

N-channel 800 V, 0.29 Ω typ., 14 A MDmesh™ K5 Power MOSFET in a TO-220 package

Datasheet - production data

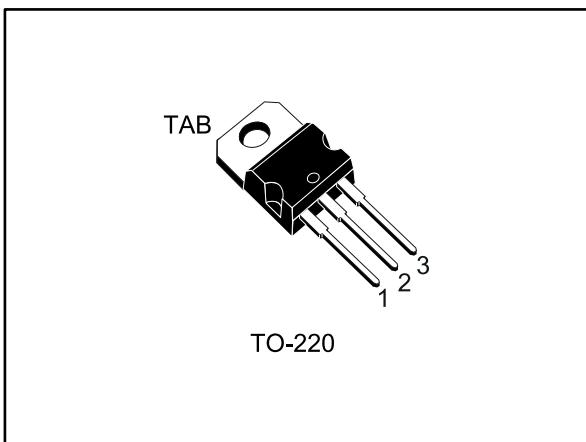
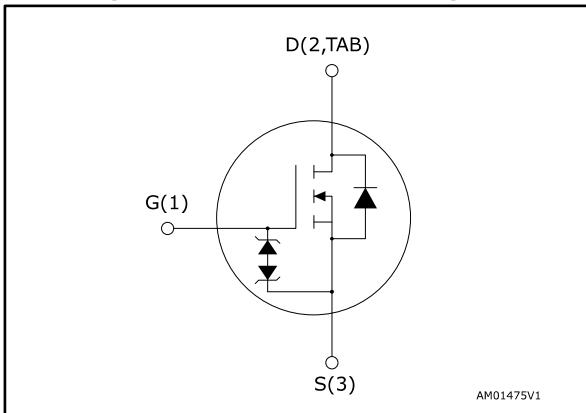


Figure 1: Internal schematic diagram



Features

| Order code | V _{DS} | R _{DS(on)} max. | I _D |
|------------|-----------------|--------------------------|----------------|
| STP17N80K5 | 800 V | 0.34 Ω | 14 A |

- Industry's lowest R_{DS(on)} x area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

- Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

| Order code | Marking | Package | Packing |
|------------|---------|---------|---------|
| STP17N80K5 | 17N80K5 | TO-220 | Tube |

Contents

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1 Electrical ratings

Table 2: Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|----------------|---|-------------|------------------|
| V_{GS} | Gate-source voltage | ± 30 | V |
| I_D | Drain current (continuous) at $T_C = 25^\circ\text{C}$ | 14 | A |
| I_D | Drain current (continuous) at $T_C = 100^\circ\text{C}$ | 9 | A |
| $I_{DM}^{(1)}$ | Drain current (pulsed) | 56 | A |
| P_{TOT} | Total dissipation at $T_C = 25^\circ\text{C}$ | 170 | W |
| $dv/dt^{(2)}$ | Peak diode recovery voltage slope | 4.5 | V/ns |
| $dv/dt^{(3)}$ | MOSFET dv/dt ruggedness | 50 | |
| T_J | Operating junction temperature range | - 55 to 150 | $^\circ\text{C}$ |
| T_{stg} | Storage temperature range | | |

Notes:

(1) Pulse width limited by safe operating area

(2) $I_{SD} \leq 14$ A, $di/dt = 100$ A/ μs ; V_{DS} peak < $V_{(BR)DSS}$, $V_{DD} = 640$ V(3) $V_{DS} \leq 640$ V**Table 3: Thermal data**

| Symbol | Parameter | Value | Unit |
|----------------|-------------------------------------|-------|---------------------------|
| $R_{thj-case}$ | Thermal resistance junction-case | 0.74 | $^\circ\text{C}/\text{W}$ |
| $R_{thj-amb}$ | Thermal resistance junction-ambient | 62.5 | $^\circ\text{C}/\text{W}$ |

Table 4: Avalanche characteristics

| Symbol | Parameter | Value | Unit |
|----------|--|-------|------|
| I_{AR} | Avalanche current, repetitive or not repetitive (pulse width limited by T_{jmax}) | 4.7 | A |
| E_{AS} | Single pulse avalanche energy (starting $T_j = 25^\circ\text{C}$, $I_D = I_{AR}$, $V_{DD} = 50$ V) | 340 | mJ |

2 Electrical characteristics

$T_C = 25^\circ\text{C}$ unless otherwise specified

Table 5: On/off-state

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------------------|-----------------------------------|--|------|------|----------|---------------|
| $V_{(\text{BR})\text{DSS}}$ | Drain-source breakdown voltage | $V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$ | 800 | | | V |
| I_{DSS} | Zero gate voltage drain current | $V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$ | | | 1 | μA |
| | | $V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$ $T_C = 125^\circ\text{C}$ ⁽¹⁾ | | | 50 | μA |
| I_{GSS} | Gate body leakage current | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$ | | | ± 10 | μA |
| $V_{GS(\text{th})}$ | Gate threshold voltage | $V_{DD} = V_{GS}, I_D = 250 \mu\text{A}$ | 3 | 4 | 5 | V |
| $R_{DS(\text{on})}$ | Static drain-source on-resistance | $V_{GS} = 10 \text{ V}, I_D = 7 \text{ A}$ | | 0.29 | 0.34 | Ω |

Notes:

⁽¹⁾Defined by design, not subject to production test.

Table 6: Dynamic

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------------------------|---------------------------------------|--|------|------|------|----------|
| C_{iss} | Input capacitance | $V_{DS} = 100 \text{ V}, f = 1 \text{ MHz}, V_{GS} = 0 \text{ V}$ | - | 866 | - | pF |
| C_{oss} | Output capacitance | | - | 64 | - | pF |
| C_{rss} | Reverse transfer capacitance | | - | 0.42 | - | pF |
| $C_{o(\text{tr})}$ ⁽¹⁾ | Equivalent capacitance time related | $V_{DS} = 0 \text{ to } 640 \text{ V}, V_{GS} = 0 \text{ V}$ | - | 142 | - | pF |
| $C_{o(\text{er})}$ ⁽²⁾ | Equivalent capacitance energy related | | - | 51 | - | pF |
| R_g | Intrinsic gate resistance | $f = 1 \text{ MHz}, I_D = 0 \text{ A}$ | - | 5 | - | Ω |
| Q_g | Total gate charge | $V_{DD} = 640 \text{ V}, I_D = 14 \text{ A}$ $V_{GS} = 10 \text{ V}$ (see Figure 15: "Test circuit for gate charge behavior") | - | 26 | - | nC |
| Q_{gs} | Gate-source charge | | - | 7.2 | - | nC |
| Q_{gd} | Gate-drain charge | | - | 15.2 | - | nC |

Notes:

⁽¹⁾ $C_{o(\text{tr})}$ is a constant capacitance value that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .

⁽²⁾ $C_{o(\text{er})}$ is a constant capacitance value that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .

Table 7: Switching times

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|--------------|---------------------|---|------|------|------|------|
| $t_{d(on)}$ | Turn-on delay time | $V_{DD} = 400 \text{ V}$, $I_D = 7 \text{ A}$, $R_G = 4.7 \Omega$ $V_{GS} = 10 \text{ V}$ (see Figure 14: "Test circuit for resistive load switching times" and Figure 19: "Switching time waveform") | - | 14.8 | - | ns |
| t_r | Rise time | | - | 10.8 | - | ns |
| $t_{d(off)}$ | Turn-off delay time | | - | 84.3 | - | ns |
| t_f | Fall time | | - | 10.1 | - | ns |

Table 8: Source-drain diode

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------|-------------------------------|---|------|------|------|---------------|
| I_{SD} | Source-drain current | | - | | 14 | A |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) | | - | | 56 | A |
| $V_{SD}^{(2)}$ | Forward on voltage | $I_{SD} = 14 \text{ A}$, $V_{GS} = 0 \text{ V}$ | - | | 1.6 | V |
| t_{rr} | Reverse recovery time | $I_{SD} = 14 \text{ A}$, $dI/dt = 100 \text{ A}/\mu\text{s}$, $V_{DD} = 60 \text{ V}$ (see Figure 16: "Test circuit for inductive load switching and diode recovery times") | - | 439 | | ns |
| Q_{rr} | Reverrse recovery charge | | - | 6.37 | | μC |
| I_{RRM} | Reverse recovery current | | - | 29 | | A |
| t_{rr} | Reverse recovery time | | - | 626 | | ns |
| Q_{rr} | Reverse recovery charge | $I_{SD} = 14 \text{ A}$, $dI/dt = 100 \text{ A}/\mu\text{s}$, $V_{DD} = 60 \text{ V}$, $T_j = 150^\circ\text{C}$ (see Figure 16: "Test circuit for inductive load switching and diode recovery times") | - | 8.36 | | μC |
| I_{RRM} | Reverse recovery current | | - | 26.7 | | A |

Notes:

(1) Pulse width limited by safe operating area

(2) Pulsed: pulse duration = 300 μs , duty cycle 1.5%

Table 9: Gate-source Zener diode

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|---------------|-------------------------------|---|------|------|------|------|
| $V_{(BR)GSO}$ | Gate-source breakdown voltage | $I_{GS} = \pm 1 \text{ mA}$, $I_D = 0 \text{ A}$ | 30 | - | - | V |

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

2.2 Electrical characteristics (curves)

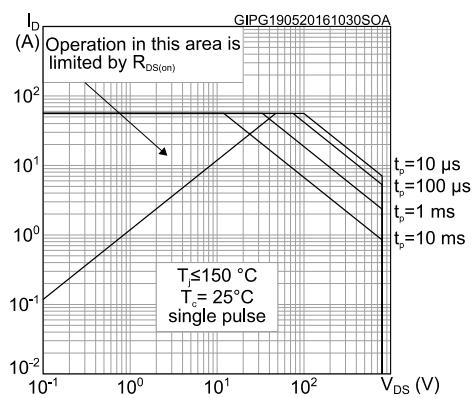
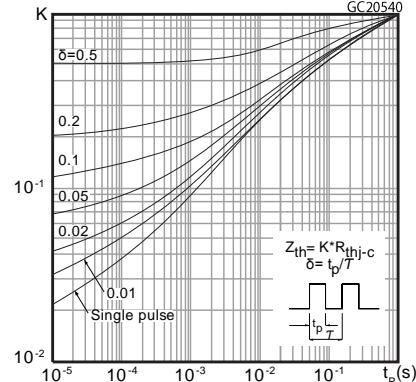
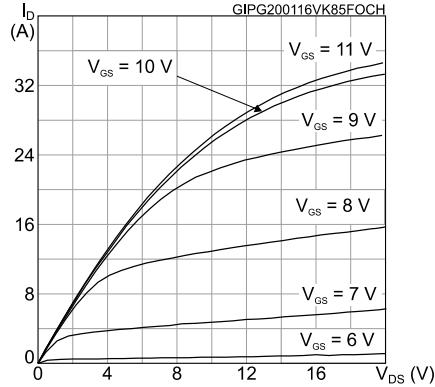
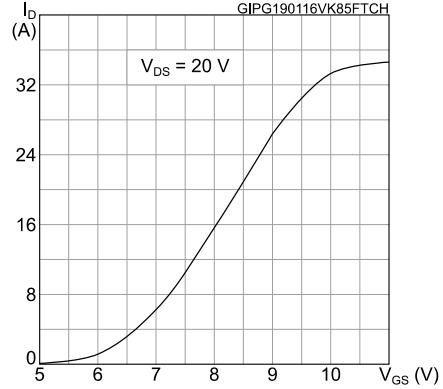
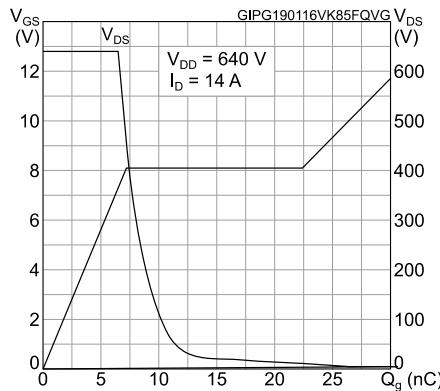
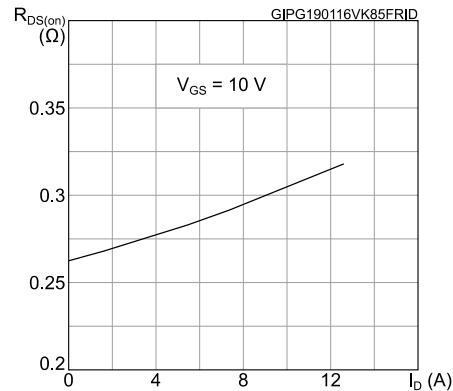
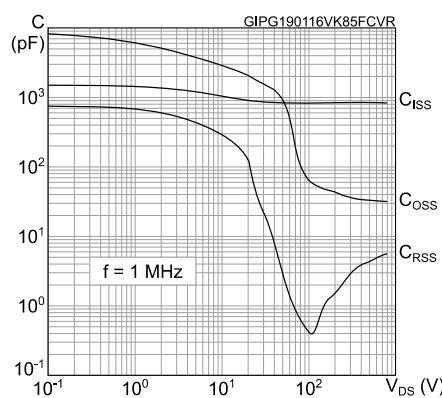
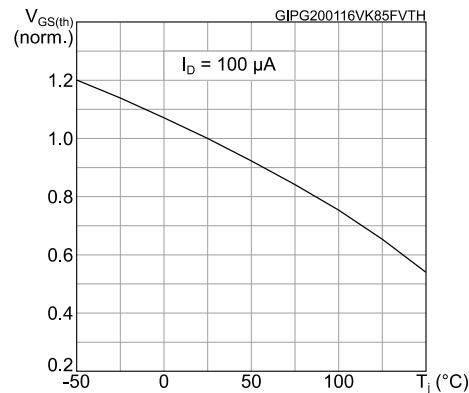
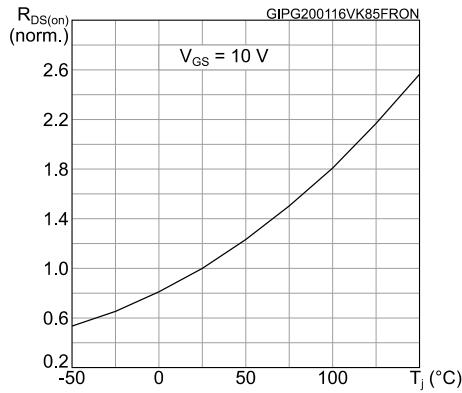
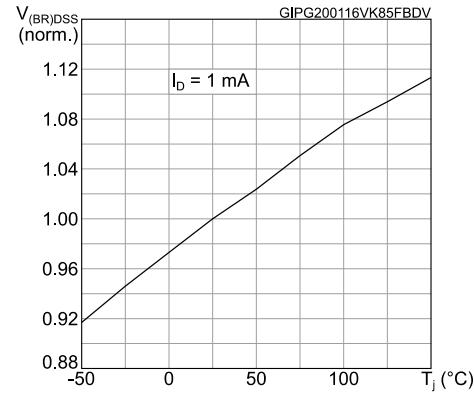
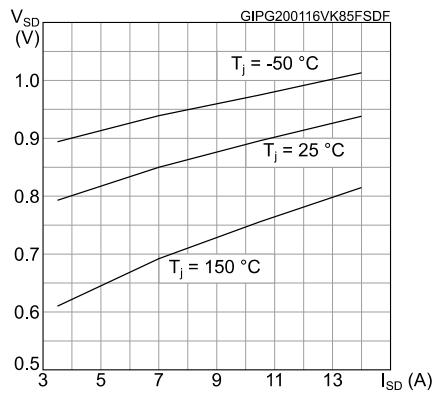
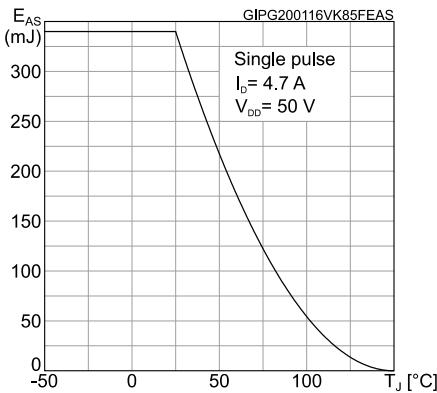
Figure 2: Safe operating area**Figure 3: Thermal impedance****Figure 4: Output characteristics****Figure 5: Transfer characteristics****Figure 6: Gate charge vs gate-source voltage****Figure 7: Static drain-source on-resistance**

Figure 8: Capacitance variations**Figure 9: Normalized gate threshold voltage vs temperature****Figure 10: Normalized on-resistance vs temperature****Figure 11: Normalized $V_{(BR)DSS}$ vs temperature****Figure 12: Source-drain diode forward characteristics****Figure 13: Maximum avalanche energy vs starting T_J** 

3 Test circuits

Figure 14: Test circuit for resistive load switching times

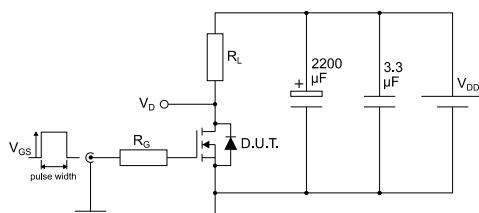


Figure 15: Test circuit for gate charge behavior

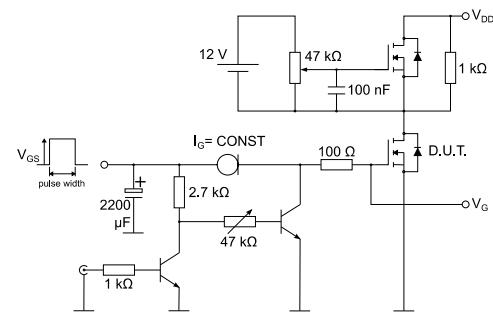


Figure 16: Test circuit for inductive load switching and diode recovery times

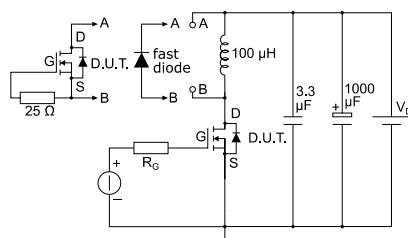


Figure 17: Unclamped inductive load test circuit

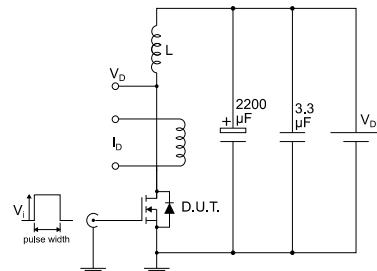


Figure 18: Unclamped inductive waveform

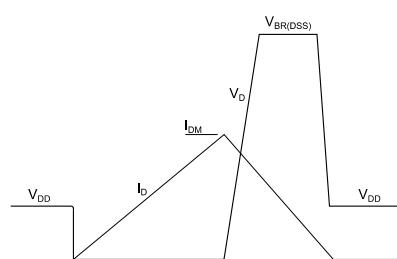
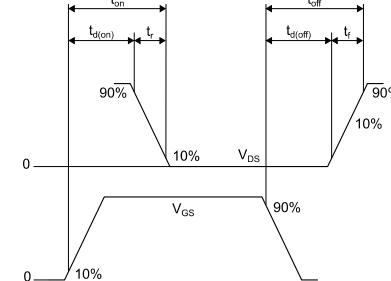


Figure 19: Switching time waveform



4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com.
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4.1 TO-220 type A package information

Figure 20: TO-220 type A package outline

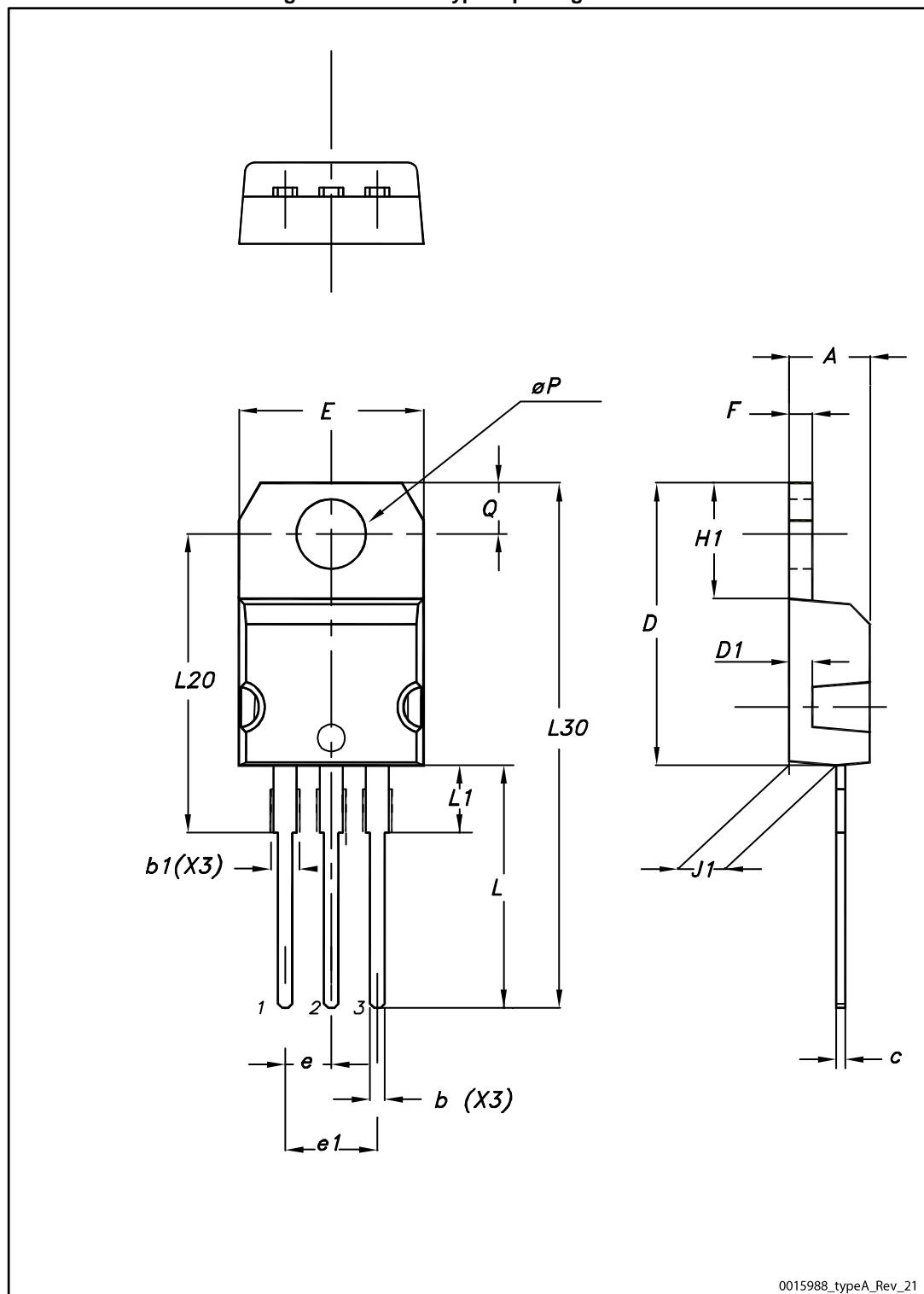


Table 10: TO-220 type A mechanical data

| Dim. | mm | | |
|------|-------|-------|-------|
| | Min. | Typ. | Max. |
| A | 4.40 | | 4.60 |
| b | 0.61 | | 0.88 |
| b1 | 1.14 | | 1.55 |
| c | 0.48 | | 0.70 |
| D | 15.25 | | 15.75 |
| D1 | | 1.27 | |
| E | 10.00 | | 10.40 |
| e | 2.40 | | 2.70 |
| e1 | 4.95 | | 5.15 |
| F | 1.23 | | 1.32 |
| H1 | 6.20 | | 6.60 |
| J1 | 2.40 | | 2.72 |
| L | 13.00 | | 14.00 |
| L1 | 3.50 | | 3.93 |
| L20 | | 16.40 | |
| L30 | | 28.90 | |
| øP | 3.75 | | 3.85 |
| Q | 2.65 | | 2.95 |

5 Revision history

Table 11: Document revision history

| Date | Revision | Changes |
|-------------|----------|---|
| 03-Apr-2015 | 1 | First release. |
| 19-May-2016 | 2 | Modified: <i>Table 2: "Absolute maximum ratings"</i> , <i>Table 3: "Thermal data"</i> Added: <i>Section 3.1: "Electrical characteristics (curves)"</i> Minor text changes |

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